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PATENT NUMBER and  
ISSUE DATE

U.S. UTILITY Patent Application

10/069517

APPL NUM 10069517	FILING DATE 03/05/2002	CLASS 438	SUBCLASS 748	GAU 2812	EXAMINER GUERRERO
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\*\*APPLICANTS: Jaussaud Claude; Jalaguier Eric; Madar Roland;

OK MC  
\*\*CONTINUING DATA VERIFIED:

THIS APPLICATION IS A 371 OF PCT/FR00/02468 09/07/2000

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\*\*FOREIGN APPLICATIONS VERIFIED:  
FRANCE 99 11224 09/08/1999

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed	<input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO 220040US2PCT
35 USC 119 conditions met	<input type="checkbox"/> yes <input type="checkbox"/> no	
Verified and Acknowledged Examiners's initials	MC	
TITLE : Method for electrically conductive bonding between two semiconductor elements		

U.S. DEPT. OF COMM./PAT & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
ISSUE FEE			Total Claims	Print Claim for O.G.
Amount Due	Date Paid		DRAWING	
			Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> TERMINAL DISCLAIMER		Primary Examiner	Print Fig.	
		PREPARED FOR ISSUE	Application Examiner	
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